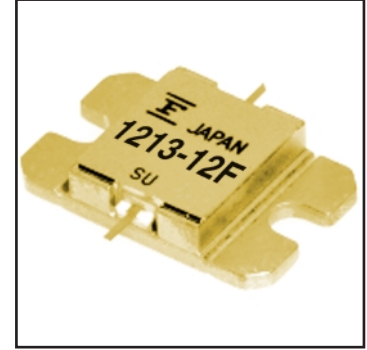


### FEATURES

- High Output Power:  $P_{1dB} = 40.5\text{dBm}$  (Typ.)
- High Gain:  $G_{1dB} = 5.5\text{dB}$  (Typ.)
- High PAE:  $\eta_{add} = 24\%$  (Typ.)
- $IM_3 = -45\text{dBc}$  @  $P_o = 28\text{dBm}$
- Broad Band: 12.7 ~ 13.2GHz
- Impedance Matched  $Z_{in}/Z_{out} = 50\Omega$
- Hermetically Sealed

### DESCRIPTION

The FLM1213-12F is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.



Fujitsu's stringent Quality Assurance Program assures the highest reliability and consistent performance.

### ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ\text{C}$ )

| Item                    | Symbol    | Condition                | Rating      | Unit             |
|-------------------------|-----------|--------------------------|-------------|------------------|
| Drain-Source Voltage    | $V_{DS}$  |                          | 15          | V                |
| Gate-Source Voltage     | $V_{GS}$  |                          | -5          | V                |
| Total Power Dissipation | $P_T$     | $T_C = 25^\circ\text{C}$ | 57.6        | W                |
| Storage Temperature     | $T_{stg}$ |                          | -65 to +175 | $^\circ\text{C}$ |
| Channel Temperature     | $T_{ch}$  |                          | 175         | $^\circ\text{C}$ |

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage ( $V_{DS}$ ) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 34.0 and -5.0 mA respectively with gate resistance of  $50\Omega$ .

### ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ\text{C}$ )

| Item                                 | Symbol          | Test Conditions                                                                                                          | Limit |      |           | Unit               |
|--------------------------------------|-----------------|--------------------------------------------------------------------------------------------------------------------------|-------|------|-----------|--------------------|
|                                      |                 |                                                                                                                          | Min.  | Typ. | Max.      |                    |
| Saturated Drain Current              | $I_{DSS}$       | $V_{DS} = 5\text{V}, V_{GS} = 0\text{V}$                                                                                 | -     | 6000 | 9000      | mA                 |
| Transconductance                     | $g_m$           | $V_{DS} = 5\text{V}, I_{DS} = 3600\text{mA}$                                                                             | -     | 5000 | -         | mS                 |
| Pinch-off Voltage                    | $V_p$           | $V_{DS} = 5\text{V}, I_{DS} = 300\text{mA}$                                                                              | -0.5  | -1.5 | -3.0      | V                  |
| Gate Source Breakdown Voltage        | $V_{GSO}$       | $I_{GS} = -340\mu\text{A}$                                                                                               | -5    | -    | -         | V                  |
| Output Power at 1dB G.C.P.           | $P_{1dB}$       | $V_{DS} = 10\text{V}$<br>$f = 12.7 \sim 13.2\text{GHz}$<br>$I_{DS} = 0.6 I_{DSS}(\text{Typ.})$<br>$Z_S = Z_L = 50\Omega$ | 39.5  | 40.5 | -         | dBm                |
| Power Gain at 1dB G.C.P.             | $G_{1dB}$       |                                                                                                                          | 4.5   | 5.5  | -         | dB                 |
| Drain Current                        | $I_{dsr}$       |                                                                                                                          | -     | 3600 | 4500      | mA                 |
| Power-Added Efficiency               | $\eta_{add}$    |                                                                                                                          | -     | 24   | -         | %                  |
| Gain Flatness                        | $\Delta G$      |                                                                                                                          | -     | -    | $\pm 0.6$ | dB                 |
| 3rd Order Intermodulation Distortion | $IM_3$          | $f = 13.2\text{GHz}, \Delta f = 10\text{MHz}$<br>2-Tone Test<br>$P_{out} = 28\text{dBm S.C.L.}$                          | -42   | -45  | -         | dBc                |
| Thermal Resistance                   | $R_{th}$        | Channel to Case                                                                                                          | -     | 2.3  | 2.6       | $^\circ\text{C/W}$ |
| Channel Temperature Rise             | $\Delta T_{ch}$ | $10\text{V} \times I_{dsr} \times R_{th}$                                                                                | -     | -    | 80        | $^\circ\text{C}$   |

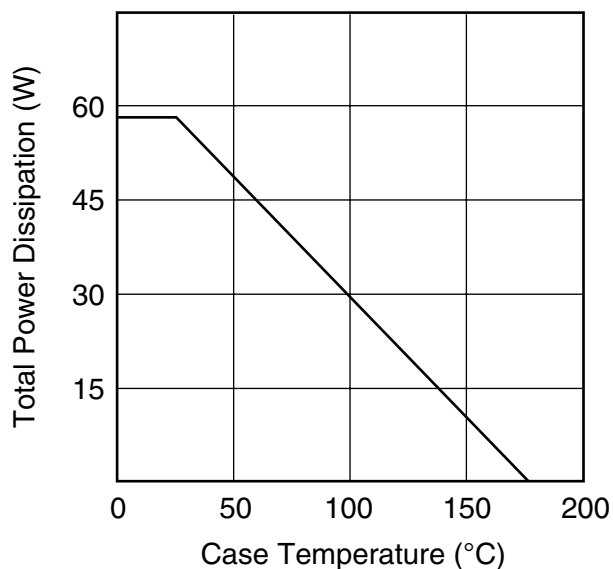
### CASE STYLE: IB

G.C.P.: Gain Compression Point

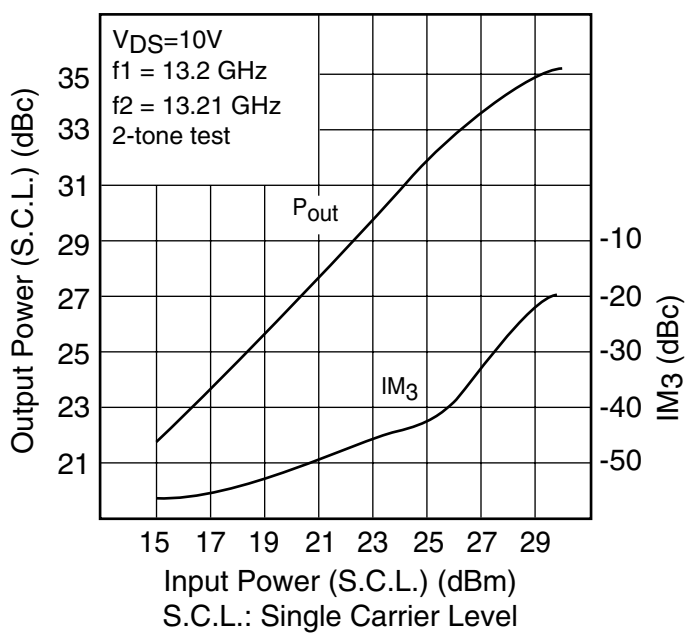
# FLM1213-12F

X, Ku-Band Internally Matched FET

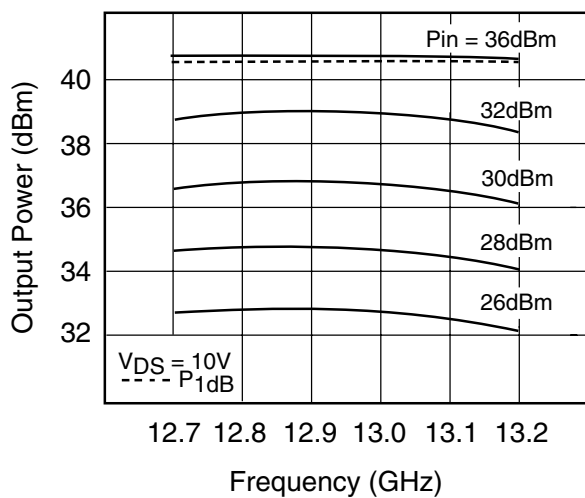
POWER DERATING CURVE



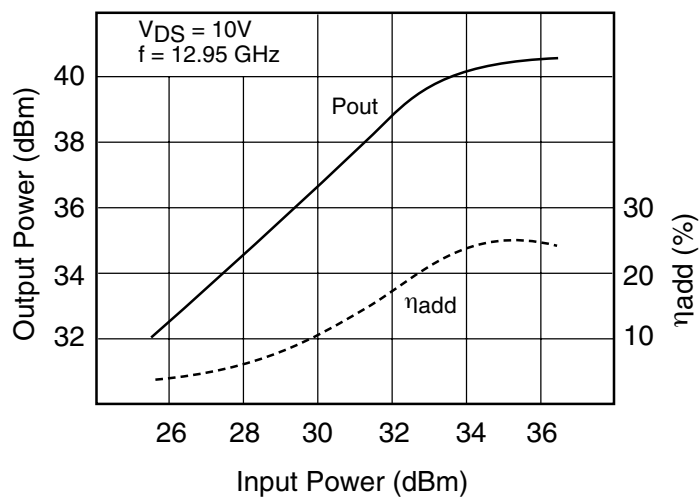
OUTPUT POWER & IM<sub>3</sub> vs. INPUT POWER



OUTPUT POWER vs. FREQUENCY

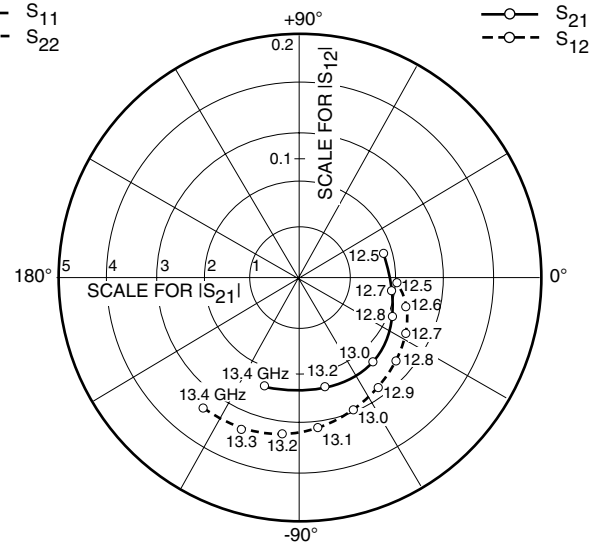
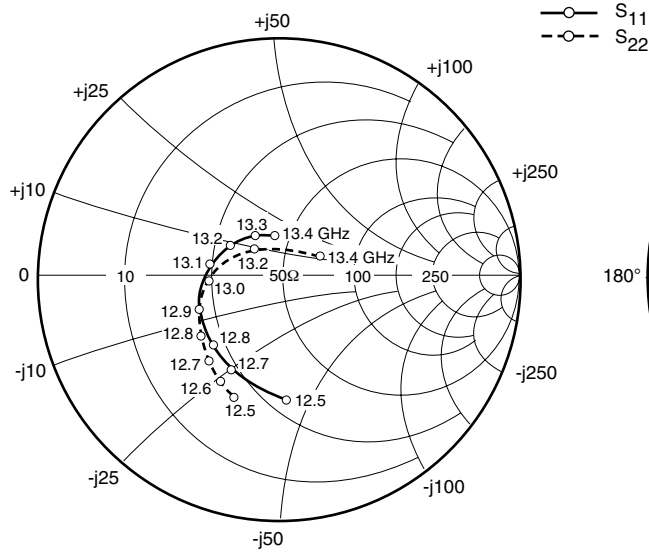


OUTPUT POWER vs. INPUT POWER



# FLM1213-12F

X, Ku-Band Internally Matched FET



## S-PARAMETERS

$V_{DS} = 10V, I_{DS} = 3600mA$

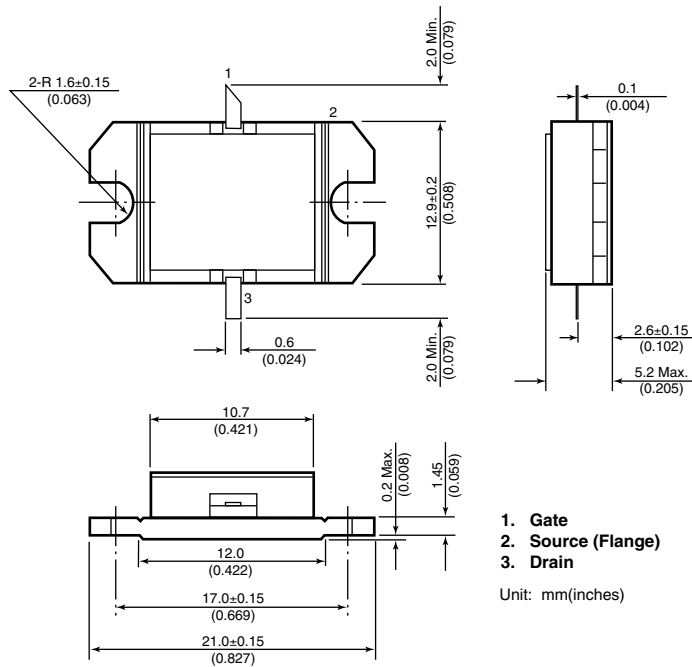
| FREQUENCY<br>(MHZ) | S11  |        | S21   |        | S12  |        | S22  |        |
|--------------------|------|--------|-------|--------|------|--------|------|--------|
|                    | MAG  | ANG    | MAG   | ANG    | MAG  | ANG    | MAG  | ANG    |
| 12500              | .511 | -86.9  | 1.787 | 16.5   | .080 | -2.7   | .531 | -110.8 |
| 12600              | .474 | -101.9 | 1.891 | 4.5    | .089 | -15.2  | .497 | -121.6 |
| 12700              | .435 | -118.0 | 1.995 | -8.2   | .098 | -27.4  | .460 | -132.6 |
| 12800              | .400 | -134.6 | 2.092 | -21.1  | .104 | -40.6  | .414 | -144.1 |
| 12900              | .360 | -152.2 | 2.192 | -34.1  | .112 | -54.4  | .362 | -158.1 |
| 13000              | .324 | -171.0 | 2.283 | -47.9  | .120 | -68.6  | .298 | -175.0 |
| 13100              | .290 | 168.5  | 2.341 | -62.2  | .127 | -82.8  | .229 | 164.7  |
| 13200              | .249 | 147.6  | 2.386 | -77.2  | .132 | -97.1  | .164 | 133.3  |
| 13300              | .212 | 125.2  | 2.369 | -91.4  | .136 | -111.6 | .127 | 82.9   |
| 13400              | .172 | 100.6  | 2.343 | -106.4 | .134 | -126.6 | .169 | 34.4   |

# FLM1213-12F

## X, Ku-Band Internally Matched FET

### Case Style "IB"

#### Metal-Ceramic Hermetic Package



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- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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